

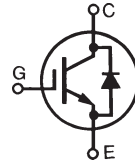
BiMOSFET™ Monolithic Bipolar MOS Transistor

IXBK75N170 IXBX75N170

$$V_{CES} = 1700V$$

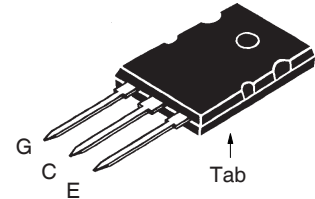
$$I_{C110} = 75A$$

$$V_{CE(sat)} \leq 3.1V$$

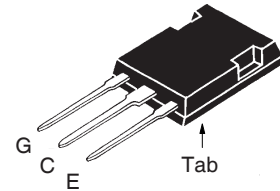


| Symbol | Test Conditions | Maximum Ratings | |
|----------------|---|---------------------------------|------------|
| V_{CES} | $T_J = 25^\circ C$ to $150^\circ C$ | 1700 | V |
| V_{CGR} | $T_J = 25^\circ C$ to $150^\circ C$, $R_{GE} = 1M\Omega$ | 1700 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ C$ (Chip Capability) | 200 | A |
| I_{LRMS} | $T_C = 25^\circ C$ (Lead RMS Limit) | 160 | A |
| I_{C110} | $T_C = 110^\circ C$ | 75 | A |
| I_{CM} | $T_C = 25^\circ C$, 1ms | 580 | A |
| SSOA | $V_{GE} = 15V$, $T_{VJ} = 125^\circ C$, $R_G = 1\Omega$ | $I_{CM} = 150$ | A |
| (RBSOA) | Clamped Inductive Load | $V_{CE} \leq 0.8 \cdot V_{CES}$ | |
| P_C | $T_C = 25^\circ C$ | 1040 | W |
| T_J | | -55 ... +150 | $^\circ C$ |
| T_{JM} | | 150 | $^\circ C$ |
| T_{stg} | | -55 ... +150 | $^\circ C$ |
| T_L | Maximum Lead Temperature for Soldering | 300 | $^\circ C$ |
| T_{SOLD} | 1.6 mm (0.062 in.) from Case for 10 | 260 | $^\circ C$ |
| M_d | Mounting Torque (TO-264) | 1.13/10 | Nm/lb.in. |
| F_c | Mounting Force (PLUS247) | 20..120/4.5..27 | N/lb. |
| Weight | TO-264 | 10 | g |
| | PLUS247 | 6 | g |

TO-264 (IXBK)



PLUS247™ (IXBX)



G = Gate C = Collector
E = Emitter Tab = Collector

Features

- International Standard Packages
- High Blocking Voltage
- High Current Handling Capability
- Anti-Parallel Diode

Advantages

- High Power Density
- Low Gate Drive Requirement
- Intergrated Diode Can Be Used for Protection

Applications

- Capacitor Discharge
- AC Switches
- Switch-Mode and Resonant-Mode Power Supplies
- UPS
- AC Motor Drives

| Symbol | Test Conditions ($T_J = 25^\circ C$, Unless Otherwise Specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|--------------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 250\mu A$, $V_{GE} = 0V$ | 1700 | | V |
| $V_{GE(th)}$ | $I_C = 1.5mA$, $V_{CE} = V_{GE}$ | 2.5 | | 5.5 V |
| I_{CES} | $V_{CE} = 0.8 \cdot V_{CES}$, $V_{GE} = 0V$ $T_J = 125^\circ C$ | | | 25 μA 2 mA |
| I_{GES} | $V_{CE} = 0V$, $V_{GE} = \pm 20V$ | | | ± 100 nA |
| $V_{CE(sat)}$ | $I_C = I_{C110}$, $V_{GE} = 15V$, Note 1 $T_J = 125^\circ C$ | 2.6 3.1 | 3.1 | V V |

Symbol Test Conditions

($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)

Characteristic Values

| Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------|---|--------------------------------|------|------|--------------------|
| | | | | | |
| g_{fs} | $I_C = I_{C110}, V_{CE} = 10V$, Note 1 | 34 | 56 | | S |
| C_{ies} | $V_{CE} = 25V, V_{GE} = 0V, f = 1\text{MHz}$ | | 6930 | | pF |
| C_{oes} | | | 400 | | pF |
| C_{res} | | | 150 | | pF |
| Q_g | $I_C = I_{C110}, V_{GE} = 15V, V_{CE} = 0.5 \cdot V_{CES}$ | | 350 | | nC |
| Q_{ge} | | | 50 | | nC |
| Q_{gc} | | | 160 | | nC |
| $t_{d(on)}$ | Resistive load, $T_J = 25^\circ\text{C}$ | | 46 | | ns |
| t_r | | $I_C = I_{C110}, V_{GE} = 15V$ | 160 | | ns |
| $t_{d(off)}$ | $R_G = 1\Omega, V_{CE} = 0.5 \cdot V_{CES}$ | | 260 | | ns |
| t_f | | | 440 | | ns |
| $t_{d(on)}$ | Resistive load, $T_J = 125^\circ\text{C}$ | | 47 | | ns |
| t_r | | $I_C = I_{C110}, V_{GE} = 15V$ | 230 | | ns |
| $t_{d(off)}$ | $R_G = 1\Omega, V_{CE} = 0.5 \cdot V_{CES}$ | | 260 | | ns |
| t_f | | | 580 | | ns |
| R_{thJC} | | | | 0.12 | $^\circ\text{C/W}$ |
| R_{thCS} | | 0.15 | | | $^\circ\text{C/W}$ |

Reverse Diode

Symbol Test Conditions

($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)

Characteristic Values

| Symbol | Test Conditions | Min. | Typ. | Max | Units |
|----------|---|---------------------------|------|-----|---------------|
| | | | | | |
| V_F | $I_F = I_{C110}, V_{GE} = 0V$, Note 1 | | | 3.0 | V |
| t_{rr} | $I_F = 37A, V_{GE} = 0V, -di_F/dt = 100A/\mu\text{s}$ | | 1.5 | | μs |
| I_{RM} | | | 50 | | A |
| Q_{RM} | | $V_R = 100V, V_{GE} = 0V$ | 38.2 | | μC |

Note

1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

Additional provisions for lead-to-lead isolation are required at $V_{CE} > 1200V$.

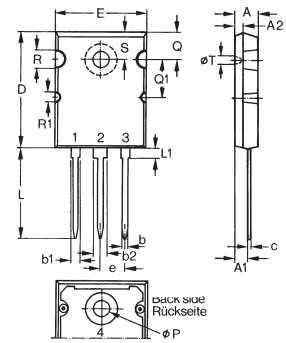
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

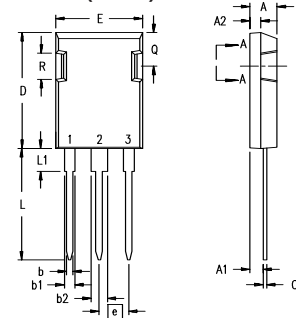
IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338 B2
by one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

TO-264 AA (IXBK) Outline



| Dim. | Millimeter | | Inches | |
|------|------------|-------|----------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.82 | 5.13 | .190 | .202 |
| A1 | 2.54 | 2.89 | .100 | .114 |
| A2 | 2.00 | 2.10 | .079 | .083 |
| b | 1.12 | 1.42 | .044 | .056 |
| b1 | 2.39 | 2.69 | .094 | .106 |
| b2 | 2.90 | 3.09 | .114 | .122 |
| c | 0.53 | 0.83 | .021 | .033 |
| D | 25.91 | 26.16 | 1.020 | 1.030 |
| E | 19.81 | 19.96 | .780 | .786 |
| e | 5.46 BSC | | .215 BSC | |
| J | 0.00 | 0.25 | .000 | .010 |
| K | 0.00 | 0.25 | .000 | .010 |
| L | 20.32 | 20.83 | .800 | .820 |
| L1 | 2.29 | 2.59 | .090 | .102 |
| P | 3.17 | 3.66 | .125 | .144 |
| Q | 6.07 | 6.27 | .239 | .247 |
| Q1 | 8.38 | 8.69 | .330 | .342 |
| R | 3.81 | 4.32 | .150 | .170 |
| R1 | 1.78 | 2.29 | .070 | .090 |
| S | 6.04 | 6.30 | .238 | .248 |
| T | 1.57 | 1.83 | .062 | .072 |

PLUS247™ (IXBX) Outline



Terminals: 1 - Gate
2 - Drain (Collector)
3 - Source (Emitter)

| Dim. | Millimeter | | Inches | |
|----------------|------------|-------|----------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.83 | 5.21 | .190 | .205 |
| A ₁ | 2.29 | 2.54 | .090 | .100 |
| A ₂ | 1.91 | 2.16 | .075 | .085 |
| b | 1.14 | 1.40 | .045 | .055 |
| b ₁ | 1.91 | 2.13 | .075 | .084 |
| b ₂ | 2.92 | 3.12 | .115 | .123 |
| C | 0.61 | 0.80 | .024 | .031 |
| D | 20.80 | 21.34 | .819 | .840 |
| E | 15.75 | 16.13 | .620 | .635 |
| e | 5.45 BSC | | .215 BSC | |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | 3.81 | 4.32 | .150 | .170 |
| Q | 5.59 | 6.20 | .220 | 0.244 |
| R | 4.32 | 4.83 | .170 | .190 |

Fig. 1. Output Characteristics
@ 25°C

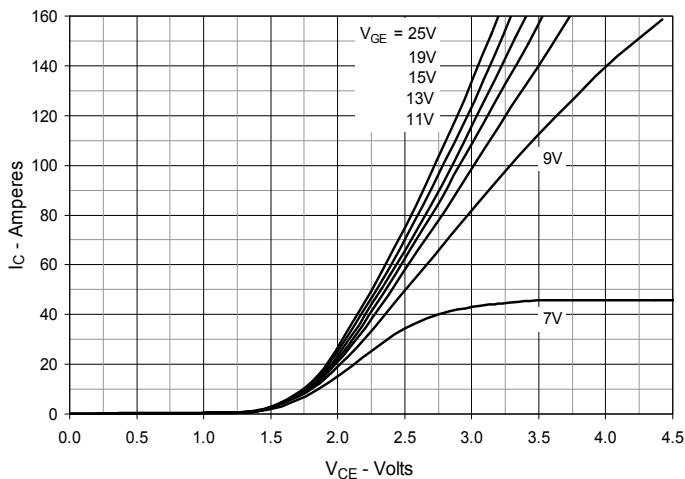


Fig. 2. Extended Output Characteristics
@ 25°C

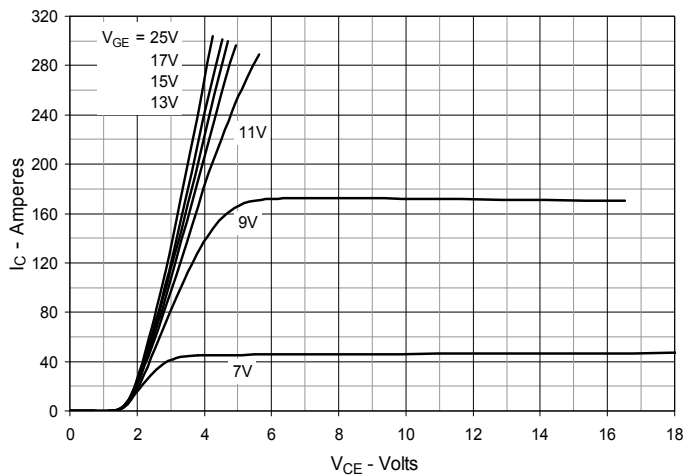


Fig. 3. Output Characteristics
@ 125°C

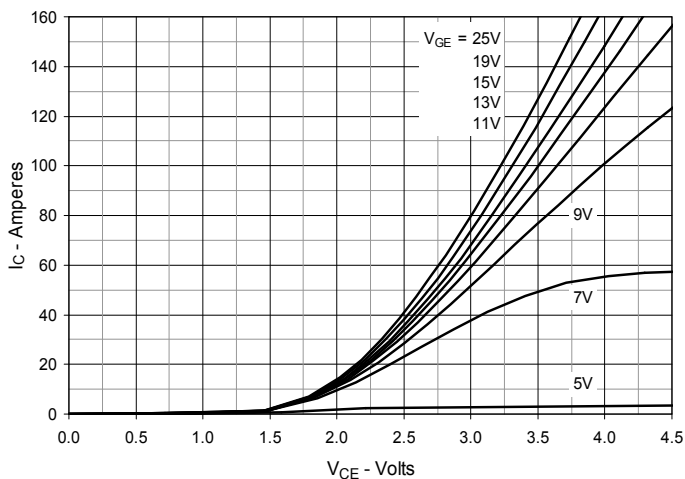


Fig. 4. Dependence of VCE(sat) on Junction Temperature

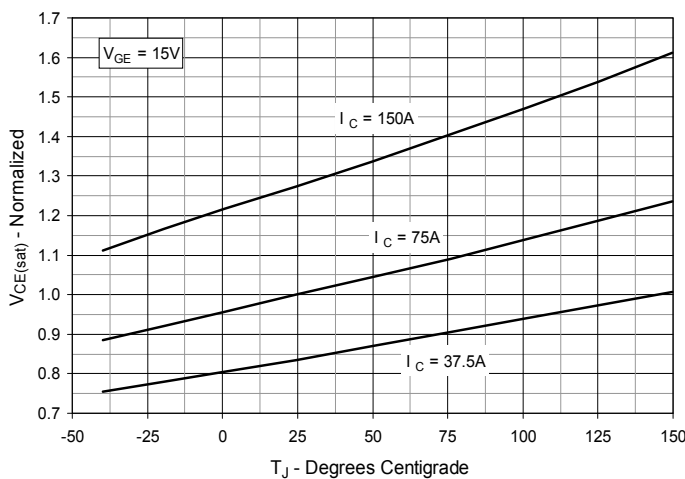


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

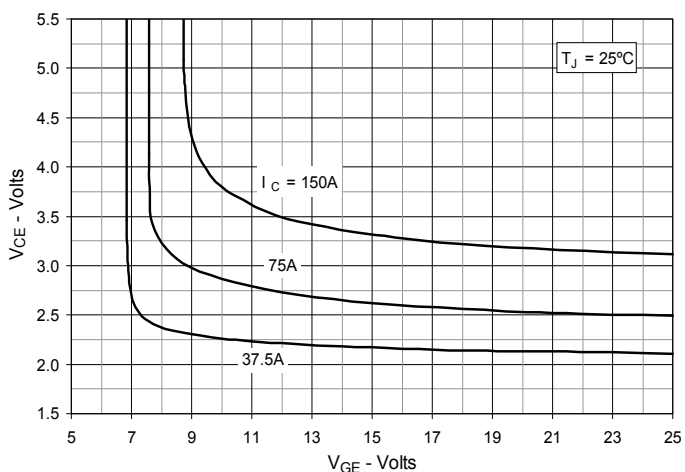


Fig. 6. Input Admittance

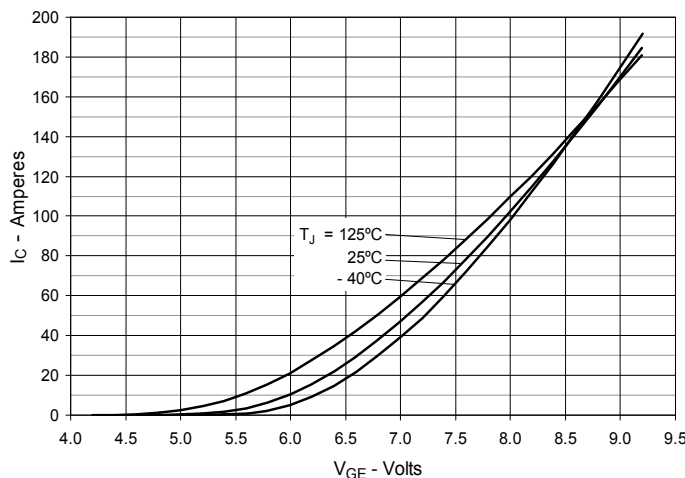


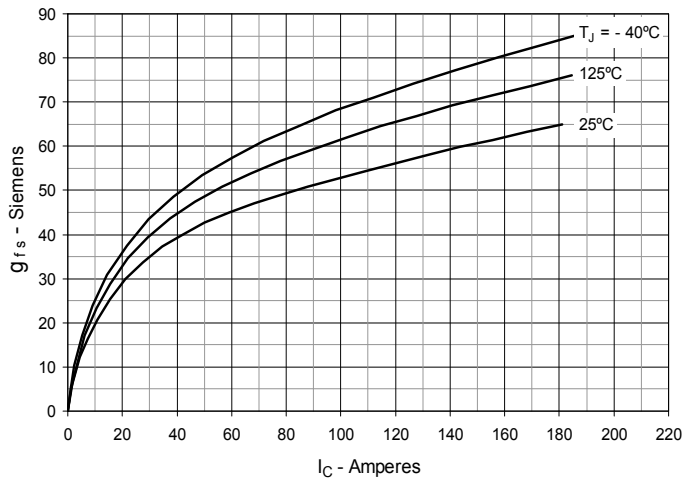
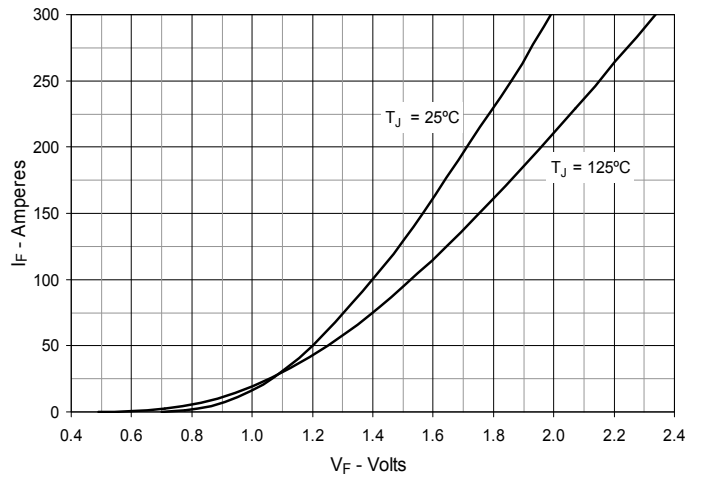
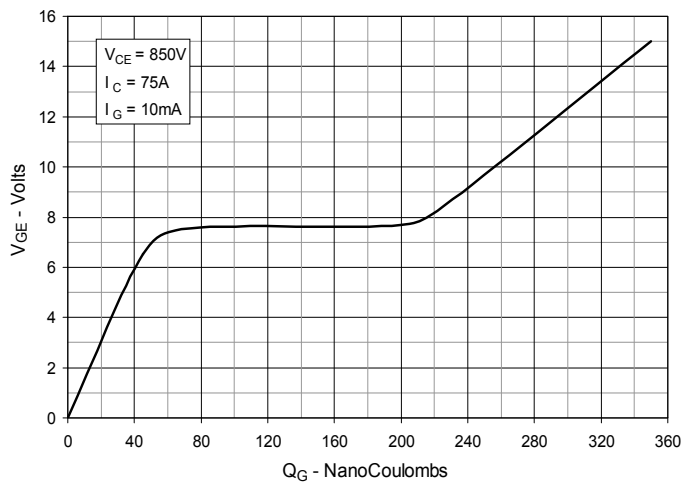
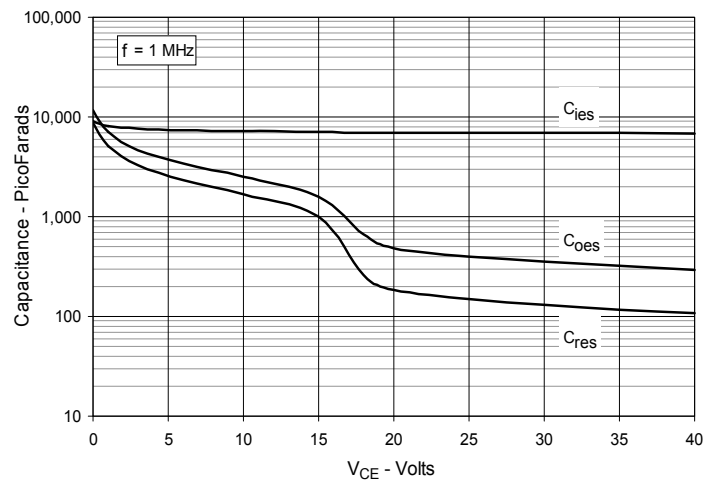
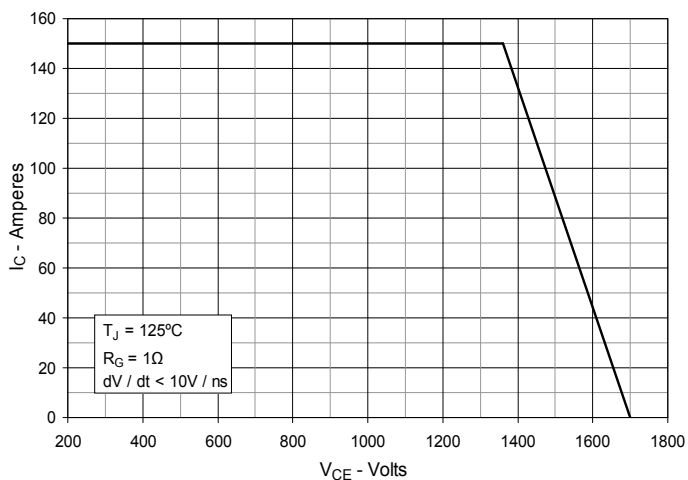
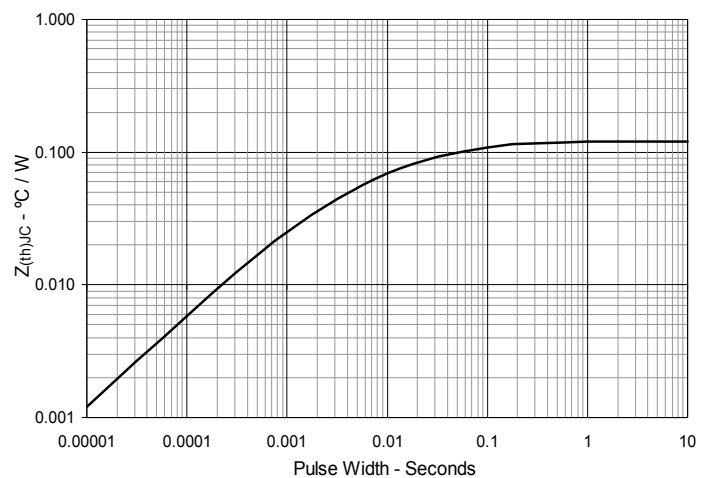
Fig. 7. Transconductance

Fig. 8. Forward Voltage Drop of Intrinsic Diode

Fig. 9. Gate Charge

Fig. 10. Capacitance

Fig. 11. Reverse-Bias Safe Operating Area

Fig. 12. Maximum Transient Thermal Impedance


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

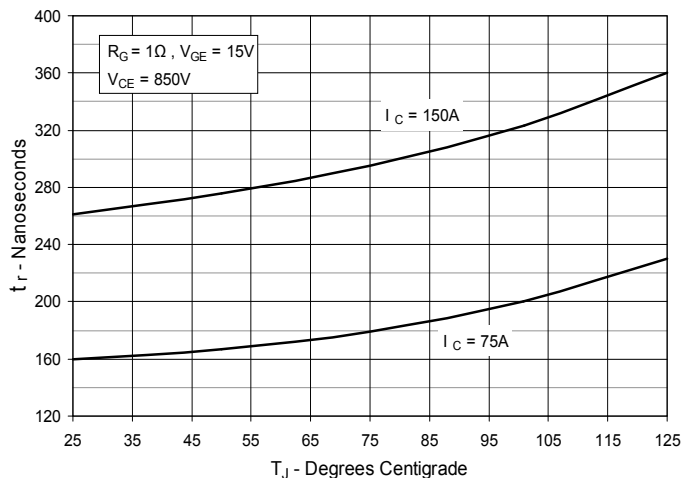


Fig. 14. Resistive Turn-on Rise Time vs. Collector Current

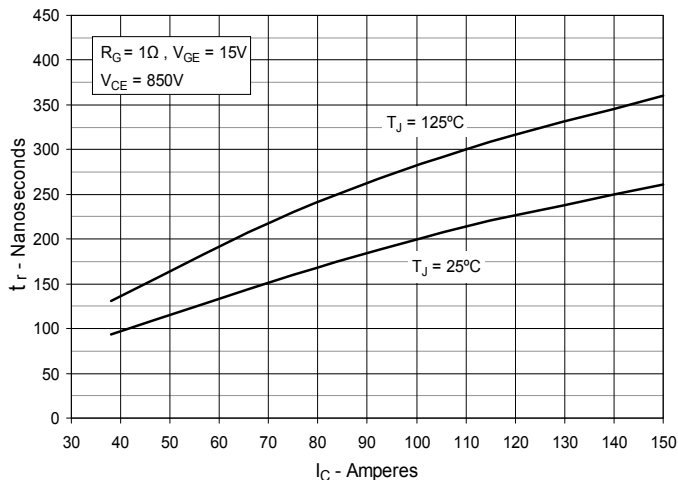


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

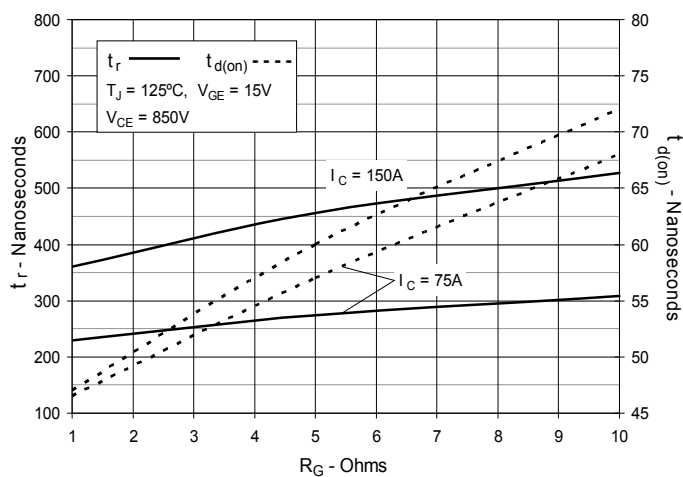


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

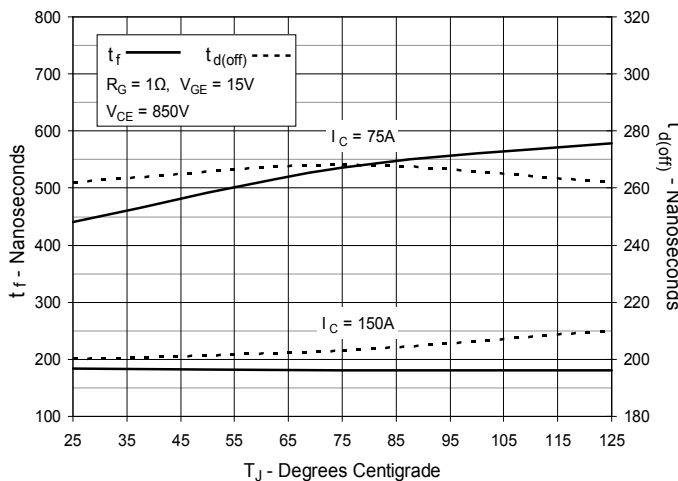


Fig. 17. Resistive Turn-off Switching Times vs. Collector Current

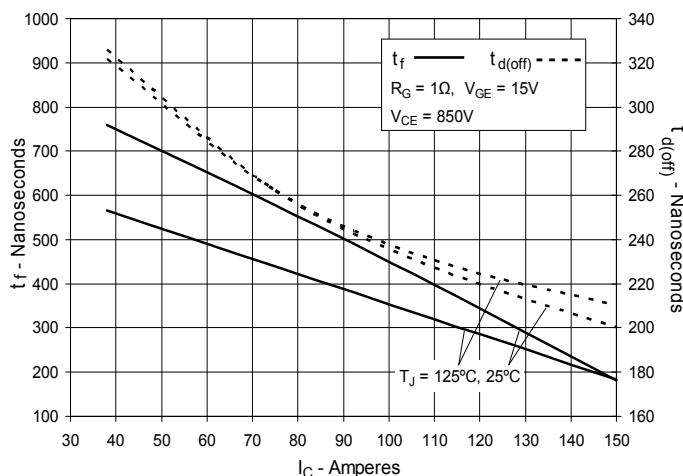
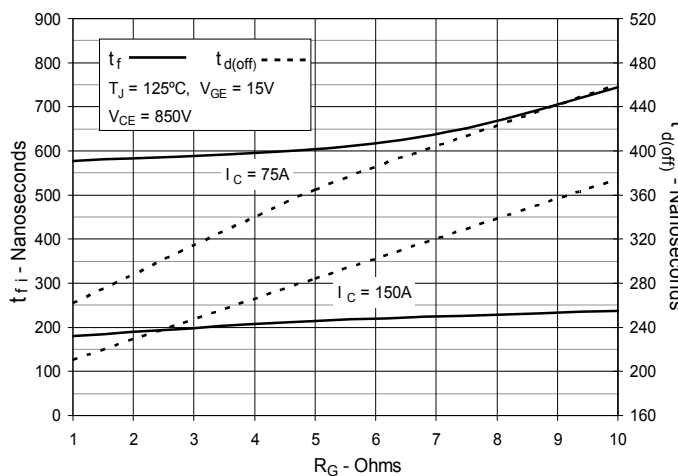


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance



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